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Mostafa Aghazadeh is Corporate Vice President and Director of Die Prep & Assembly Technology Development at Intel Corporation in Chandler, Arizona. He is responsible for development and deployment of packaging assembly process, equipment, and materials technologies and all the associated materials and equipment suppliers. He joined Intel in 1984 and has held a variety of technical and management positions in the microelectronic

packaging area. He and his team have been major contributors to development of packaging solutions, manufacturing capabilities and supply chain for Intel's products for the past 34 years. He holds six U.S. patents. Mostafa has served as a member of the iNEMI Board of Directors since 2013.

Mostafa received his bachelor's degree in mechanical engineering from the University of Tennessee and a master's degree in mechanical engineering from the Georgia Institute of Technology.

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